


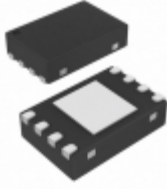
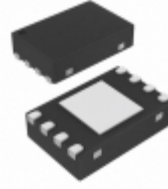
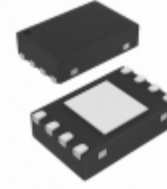

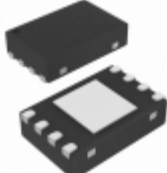

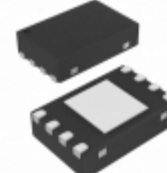
	TSE2004GB2B0NCG8	
	Hersteller-Teilenummer:	TSE2004GB2B0NCG8
	Hersteller / Marke:	IDT (Integrated Device Technology)
	Teil der Beschreibung:	TEMPERATURE SENSOR FOR DDR4
	Datenblätter:	 TSE2004GB2B0NCG8.pdf
	RoHs Status:	Bleifrei / RoHS-konform
	Lagerzustand:	New original, 495905 pcs Stock Available.
	Liefern von:	Hong Kong
	Versandweg:	DHL/Fedex/TNT/UPS/EMS
Image may be representation. See specs for product details.		

Spezifikationen

Teilenummer	TSE2004GB2B0NCG8
Hersteller	IDT (Integrated Device Technology)
Beschreibung	TEMPERATURE SENSOR FOR DDR4
Kategorie	Integrierte Schaltungen (ICs) > PMIC -
Teilstatus	495905 pcs Stock
Serie	-
Betriebstemperatur	-40°C ~ 125°C
Befestigungsart	Surface Mount
Ausgabety	I ² C/SMBus
Verpackung / Gehäuse	8-WFQFN Exposed Pad
Supplier Device-Gehäuse	8-VFQFPN (2x3)
Spannungsversorgung	2.2 V ~ 3.6 V
Funktion	Temp Monitoring System (Sensor)
Sensortyp	Internal
Topologie	ADC (Sigma Delta), Control Logic, Register Bank
Genauigkeit	±2°C
Temperaturfühler	-
Ausgangsalar	No
Ausgangslüfter	No
Verpackung	Tape & Reel (TR)

TSE2004GB2B0NCG8 ist neu im Original, Suche TSE2004GB2B0NCG8 Datenblätter, PDF, Inventar bei Y-IC.com Online, Bestellen Sie TSE2004GB2B0NCG8 IDT (Integrated Device Technology) mit Garantie und Vertrauen. Anfrage TSE2004GB2B0NCG8: Info@Y-IC.com

Sie können auch interessiert sein:

 <p>TSE2P4M TSE TSE2P4M TSE</p>	 <p>TSE2002B3CNRG8 IDT (Integrated Device Technology) IC TEMP SENS EEPROM DFN-8</p>	 <p>TSE2002GB2A1NCG8 IDT (Integrated Device Technology) IC TEMP SENS EEPROM DFN-8</p>	 <p>TSE2002GB2A1NRG IDT (Integrated Device Technology) IC TEMP SENS EEPROM DFN-8</p>
 <p>TSE3941-150G MG Chemicals ADHESIVE SEAL SIL WH FAST CURE</p>	 <p>TSE2002GB2A1NRG8 IDT (Integrated Device Technology) IC TEMP SENS EEPROM DFN-8</p>	 <p>TSE397C-100G MG Chemicals ADHESIVE SEAL SIL NON-CORROSIVE</p>	 <p>TSE2002GB2A1NCG IDT (Integrated Device Technology) IC TEMP SENS EEPROM DFN-8</p>

heiße Teile

Mehr

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|----------------------|---------------------|--------------------|----------------------|----------------------|
| ⚙ 1808SC221MAT1A | ➡ 280373-2 | ➡ ADP1173AR-5 | D AP2280-2WG-7 | ➡ BSC119N03NS3G |
| ⊣ BTS410H2 | ⚙ BUK9608-55B | D C10T04Q-TE24L1 | ➡ D3FP4-5063 | ➡ ELM9335AB-S |
| ⚙ ESDA6V1W5 | ⊣ FDS6680S | ⚙ FQPF22N30 | ➡ GJM1555C1H1R5CB01D | ➡ GRM0336R1E3R4CD01D |
| D GRM1555C1H6R3BZ01D | ⚙ GT28F160C3BA-90. | ⊣ HAT2040R-E | ⚙ IRFS634B-FP001 | ➡ IRKC71-04 |
| ➡ K6X1008T2D-GF70 | ➡ LD061C103KAB4A | ⚙ LT3597EUHG#PBF | ⊣ M30260F8AGP#U3A | ➡ M5661P-A1C |
| ➡ MA3S132D0LMR+ | ➡ MAX232AESE | D MOS48GN50 | ⚙ PD3S230LQ-7 | ⊣ PK75FG120 |
| ⚙ R2A11055FP | D RT9011-GMPJ6 | ➡ S-1200B28-M5T1G | ➡ SKY13251-349 | ➡ SKY13441-11 |
| ⊣ SN75HVD3085EDRG4 | ⚙ TC1073-2.85VCH713 | ➡ TC55RP5002ECB713 | ➡ TC7660-HC/OA | ➡ TCS1301_C |
| ⚙ TDA3673T/N1 | ⊣ TSE100-8 | ⚙ TSE2002B3CNRG. | D TSE2002GB2A1NCG8 | ➡ TSE2004GB2BONCG8 |
| ➡ UT4812G-S08-R | ⚙ VI-254-IX | ⊣ VI-260-CX-F2 | ⚙ VI-BW4-IV | ➡ VI-J01-IX |

Contact us: Info@Y-IC.com

HINZUFÜGEN: Einheit A5-B5 Nr.509, 5 / F Sing Win Fabrikgebäude, 15-17 Shing Yip St, Kwun Tong, Kowloon, HongKong.

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